



#### DMWSH120H90SCT7Q

# 1200V N-CHANNEL SILICON CARBIDE POWER MOSFET

## **Product Summary**

BV <sub>DSS</sub>	RDS(ON) MAX	I <sub>D</sub> Tc = +25°C	
1200V	90mΩ @ V <sub>GS</sub> = 15V	38.2	

#### **Features and Benefits**

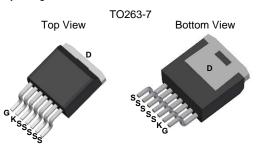
- Low On-Resistance
- High BV<sub>DSS</sub> Rating for Power Application
- Low Input Capacitance
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMWSH120H90SCT7Q is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

## **Description and Applications**

This SiC MOSFET is designed to minimize the on-state resistance yet maintain superior switching performance, making it ideal for high-efficiency power-management applications.

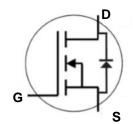
- Switch mode power supplies
- Motor drives
- High-voltage DC-DC converters
- Solar inverters
- EV battery chargers



Pin Configuration

#### **Mechanical Data**

- Package: TO263-7
- Package Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
   Solderable per MIL-STD-202, Method 208 @3
- Weight: 1.524 grams (Approximate)



K (driver source)

Internal Schematic

### Ordering Information (Note 4)

Part Number	Paskage	Packing		
Fait Number	Package	Qty.	Carrier	
DMWSH120H90SCT7Q	TO263-7	50	Tube	
DMWSH120H90SCT7Q-13	TO263-7	800	Tape & Reel	

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

# **Marking Information**



Dil = Manufacturer's Marking
WSH120H90SCT7 = Product Type Marking Code
YYWW = Date Code Marking
YY = Last Two Digits of Year (ex: 24 = 2024)
WW = Week Code (01 to 53)



## **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit		
Drain-Source Voltage		$V_{DSS}$	1200	V		
Gate-Source Voltage (Dynamic)		Gate-Source Voltage (Dynamic)		Vgss	+19/-8	V
Gate-Source Voltage (Static)	$V_{GSS}$	+15/-4	V			
Continuous Drain Current (Notes 5 & 6)	Tc = +25°C Tc = +100°C	I <sub>D</sub>	38.2 27.0	А		
Continuous Diode Forward Current (Note 5)	Is	34	Α			
Pulsed Source Current (Pulse Width tp Limited by TJ Max) (Note 5)	Isм	97	Α			
Pulsed Drain Current (Pulse Width tp Limited by T <sub>J Max</sub> ) (Note 5)		Ірм	97	Α		

## Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Total Dawar Dissination (Note 5)	Tc = +25°C	Ď.	197	- W	
Total Power Dissipation (Note 5)	T <sub>C</sub> = +100°C	PD	99		
Thermal Resistance, Junction to Ambient (Note 7)		Reja	58.5	°C/W	
Thermal Resistance, Junction to Case (Note 5)		Rejc	0.76	C/VV	
Operating and Storage Temperature Range		TJ, TSTG	-55 to +175	°C	

# Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	1200	_	_	V	$V_{GS} = 0V, I_{D} = 100\mu A$	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	_	50	μΑ	V <sub>DS</sub> = 1200V, V <sub>GS</sub> = 0V	
Gate-Source Leakage	Igss	_	_	±200	nA	V <sub>GS</sub> = +15/-4V, V <sub>DS</sub> = 0V	
ON CHARACTERISTICS (Note 8)	ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	Vgs(TH)	1.7	2.5	3.5	V	$V_{DS} = V_{GS}$ , $I_D = 5mA$	
Static Drain-Source On-Resistance	RDS(ON)	_	75	90	mΩ	V <sub>G</sub> S = 15V, I <sub>D</sub> = 20A	
Diode Forward Voltage	VsD	_	4.5	_	V	V <sub>G</sub> S = -4V, I <sub>S</sub> = 10A	
Transconductance	gfs	-	5.0	_	S	$VDS = 20V, I_D = 20A$	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	Ciss	_	1078	_			
Output Capacitance	Coss	-	57	_	pF	V <sub>G</sub> S = 0V, V <sub>D</sub> S = 1000V	
Reverse Transfer Capacitance	Crss	_	4.9	_		$V_{AC} = 25 \text{mV}, f = 1 \text{MHz}$	
Coss Stored Energy	Eoss	-	34.2	_	μJ		
Turn-On Switching Energy (Body Diode FWD)	Eon	_	175	_	1	$V_{GS} = -4V/+15V$ , $V_{DS} = 800V$ $R_g = 5\Omega$ , $I_D = 20A$ , $L = 156\mu H$	
Turn-Off Switching Energy (Body Diode FWD)	E <sub>OFF</sub>	-	56	_	μJ		
Gate Resistance	Rg	1	2.79	_	Ω	$V_{AC} = 100 \text{mV}, f = 1 \text{MHz}$	
Total Gate Charge	Qg	_	54.6	_		V <sub>GS</sub> = -4V/+15V, V <sub>DS</sub> = 800V I <sub>D</sub> = 20A	
Gate-Source Charge	Qgs	-	16.5	_	nC		
Gate-Drain Charge	$Q_{gd}$	1	22.4	_			
Turn-On Delay Time	td(on)	_	9.1	_			
Turn-On Rise Time	t <sub>R</sub>	-	18.8	_	no	$V_{GS} = -4V/+15V$ , $V_{DS} = 800V$ $R_g = 5\Omega$ , $I_D = 20A$ Inductive Load	
Turn-Off Delay Time	tD(OFF)	1	17.2	_	ns		
Turn-Off Fall Time	t <sub>F</sub>	1	8.5	_			
Body Diode Reverse Recovery Time	t <sub>RR</sub>		11.5	_	ns		
Body Diode Reverse Recovery Charge	Q <sub>RR</sub>		108	_	nC	$V_{GS} = -4V$ , $V_{DS} = 800V$ $I_{F} = 20A$ , $di/dt = 3600A/\mu s$	
Body Diode Reverse Recovery Current	IRRM	_	18.8	_	Α	15 - 20/1, di/dt - 3000/148	

Notes:

- 5. Device mounted on an infinite heatsink.
- 6. Drain current limited by maximum junction temperature.
- 7. Device mounted on FR-4 substrate PC board, 2oz. copper, with minimum recommended pad layout.
- 8. Short duration pulse test used to minimize self-heating effect.
- 9. Guaranteed by design. Not subject to production testing.





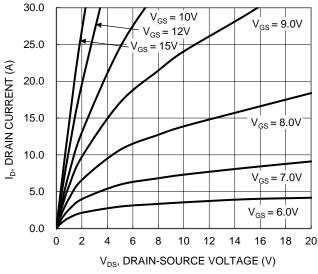


Figure 1. Typical Output Characteristic

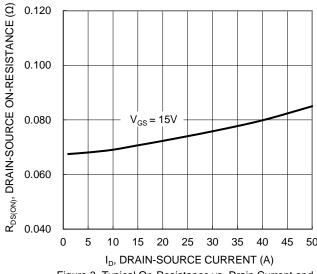


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

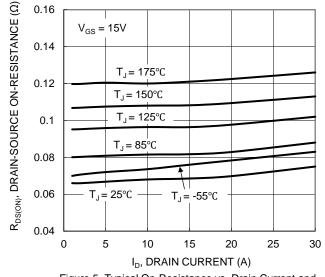


Figure 5. Typical On-Resistance vs. Drain Current and Temperature

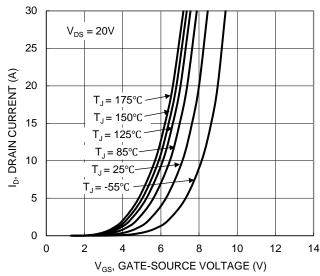


Figure 2. Typical Transfer Characteristic

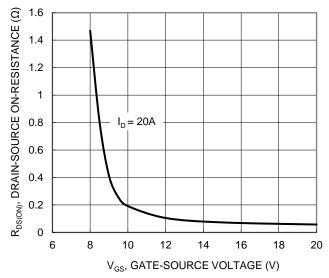


Figure 4. Typical Transfer Characteristic

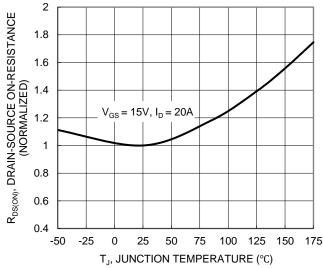


Figure 6. On-Resistance Variation with Junction Temperature





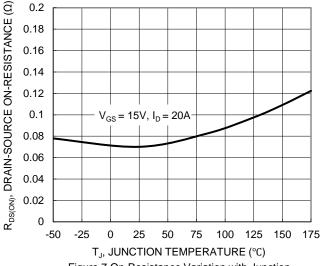
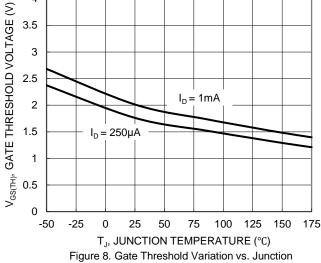
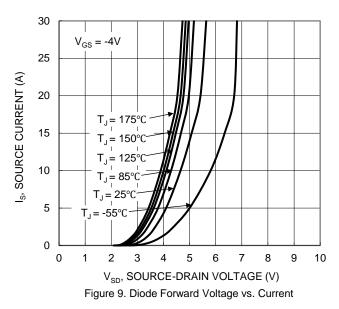


Figure 7.On-Resistance Variation with Junction Temperature



Temperature



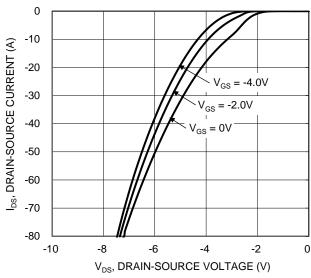


Figure 10. Body Diode Characteristic at 25°C

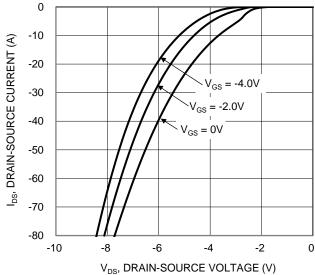


Figure 11. Body Diode Characteristic at -55°C

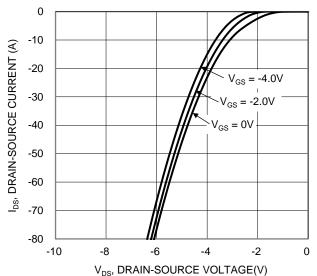
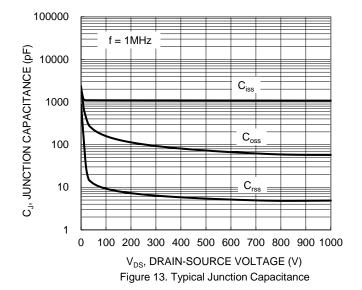
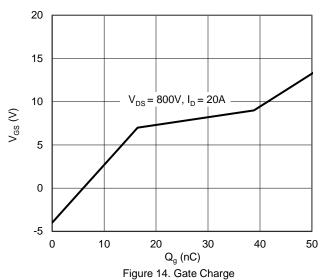


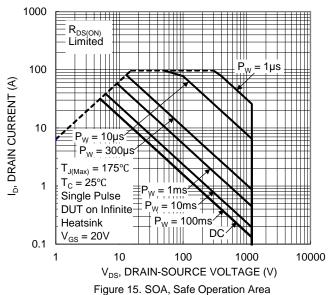
Figure 12. Body Diode Characteristic at 175°C

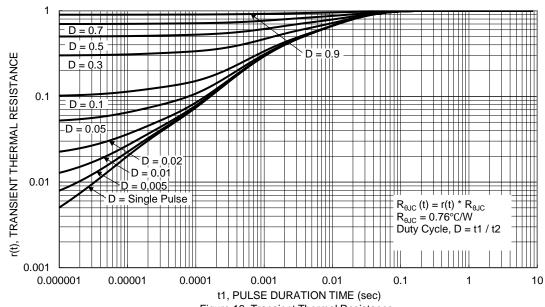










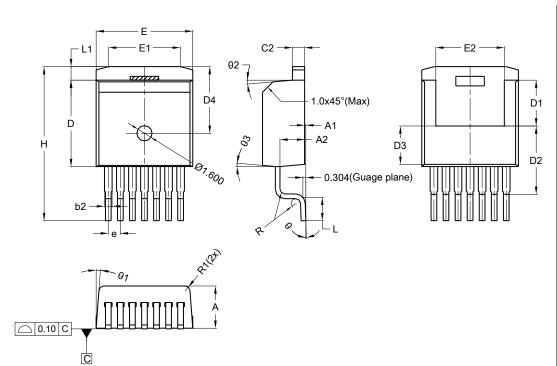




# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### TO263-7

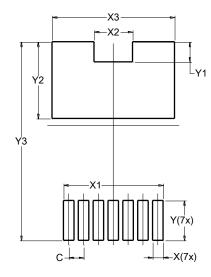


TO263-7					
Dim	Min Max Typ				
Α	4.30	4.570	4.435		
A1	0.00	0.25	0.125		
A2	2.	595 RE	F		
b	0.500	0.700	0.600		
b2	0.600	1.000	0.800		
С	0.330	0.650	0.490		
c2	1.170	1.400	1.285		
D	9.025	9.125			
D1	4.700	4.900	4.800		
D2	7.	170 RE	F		
D3	4.000 MIN				
D4	7.000 REF				
е		.27 TYF			
Е	10.130	10.230	10.180		
E1	6.500	8.600	7.550		
E2	6.778	7.665	7.223		
Н	15.043	17.313			
L	2.324	2.700	2.512		
L1	0.968	1.868	1.418		
R	0.506 REF				
R1	0.500 REF				
θ	0°	8°	4°		
θ1	4.5°	5.5°	5°		
θ2	4° 6°		5°		
θ3	4°	6°	5°		
All Dimensions in mm					

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

TO263-7



Dimensions	Value (in mm)		
C	1.270		
X	0.900		
X1	8.520		
X2	3.300		
Х3	10.480		
Y	3.400		
Y1	1.718		
Y2	6.538		
Y3	16.928		



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